

Technische Information / technical information

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IGBT-Module
IGBT-Modules

FZ1200R12KE3



vorläufige Daten
preliminary data

Höchstzulässige Werte / maximum rated values

Elektrische Eigenschaften / electrical properties

Kollektor Emitter Sperrspannung collector emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Kollektor Dauergleichstrom DC collector current	$T_c = 80^{\circ}\text{C}$ $T_c = 25^{\circ}\text{C}$	$I_{C, nom}$ I_C	1200 1700	A A
Periodischer Kollektor Spitzenstrom repetitive peak collector current	$t_p = 1\text{ms}$, $T_c = 80^{\circ}\text{C}$	I_{CRM}	2400	A
Gesamt Verlustleistung total power dissipation	$T_c = 25^{\circ}\text{C}$; Transistor	P_{tot}	5,6	kW
Gate Emitter Spitzenspannung gate emitter peak voltage		V_{GES}	+/- 20	V
Dauergleichstrom DC forward current		I_F	1200	A
Periodischer Spitzenstrom repetitive peak forward current	$t_p = 1\text{ms}$	I_{FRM}	2400	A
Grenzlastintegral I^2t value	$V_R = 0\text{V}$, $t_p = 10\text{ms}$, $T_{vj} = 125^{\circ}\text{C}$	I^2t	300	$\text{k A}^2\text{s}$
Isolations Prüfspannung insulation test voltage	RMS, $f = 50\text{Hz}$, $t = 1\text{min.}$	V_{ISOL}	2,5	kV

Charakteristische Werte / characteristic values

Transistor Wechselrichter / transistor inverter

			min.	typ.	max.	
Kollektor Emitter Sättigungsspannung collector emitter saturation voltage	$I_C = 1200\text{A}$, $V_{GE} = 15\text{V}$, $T_{vj} = 25^{\circ}\text{C}$,	V_{CESat}	-	1,7	2,15	V
	$I_C = 1200\text{A}$, $V_{GE} = 15\text{V}$, $T_{vj} = 125^{\circ}\text{C}$,		-	2	t.b.d.	V
Gate Schwellenspannung gate threshold voltage	$I_C = 48\text{mA}$, $V_{CE} = V_{GE}$, $T_{vj} = 25^{\circ}\text{C}$,	$V_{GE(th)}$	5	5,8	6,5	V
Gateladung gate charge	$V_{GE} = -15\text{V} \dots +15\text{V}$; $V_{CE} = \dots \text{V}$	Q_G	-	11,5	-	μC
Eingangskapazität input capacitance	$f = 1\text{MHz}$, $T_{vj} = 25^{\circ}\text{C}$, $V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$	C_{ies}	-	86	-	nF
Rückwirkungskapazität reverse transfer capacitance	$f = 1\text{MHz}$, $T_{vj} = 25^{\circ}\text{C}$, $V_{CE} = 25\text{V}$, $V_{GE} = 0\text{V}$	C_{res}	-	4	-	nF
Kollektor Emitter Reststrom collector emitter cut off current	$V_{CE} = 1200\text{V}$, $V_{GE} = 0\text{V}$, $T_{vj} = 25^{\circ}\text{C}$,	I_{CES}	-	-	5	mA
Gate Emitter Reststrom gate emitter leakage current	$V_{CE} = 0\text{V}$, $V_{GE} = 20\text{V}$, $T_{vj} = 25^{\circ}\text{C}$	I_{GES}	-	-	400	nA

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Charakteristische Werte / characteristic values

Transistor Wechselrichter / transistor inverter

			min.	typ.	max.	
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	$I_C = 1200A, V_{CC} = 600V$	$t_{d,on}$	-	0,54	-	μs
	$V_{GE} = \pm 15V, R_{Gon} = 1,8\Omega, T_{vj} = 25^\circ C$ $V_{GE} = \pm 15V, R_{Gon} = 1,8\Omega, T_{vj} = 125^\circ C$		-	0,64	-	μs
Anstiegszeit (induktive Last) rise time (inductive load)	$I_C = 1200A, V_{CC} = 600V$	t_r	-	0,22	-	μs
	$V_{GE} = \pm 15V, R_{Gon} = 1,8\Omega, T_{vj} = 25^\circ C$ $V_{GE} = \pm 15V, R_{Gon} = 1,8\Omega, T_{vj} = 125^\circ C$		-	0,23	-	μs
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	$I_C = 1200A, V_{CC} = 600V$	$t_{d,off}$	-	0,82	-	μs
	$V_{GE} = \pm 15V, R_{Goff} = 0,62\Omega, T_{vj} = 25^\circ C$ $V_{GE} = \pm 15V, R_{Goff} = 0,62\Omega, T_{vj} = 125^\circ C$		-	0,96	-	μs
Fallzeit (induktive Last) fall time (inductive load)	$I_C = 1200A, V_{CC} = 600V$	t_f	-	0,15	-	μs
	$V_{GE} = \pm 15V, R_{Goff} = 0,62\Omega, T_{vj} = 25^\circ C$ $V_{GE} = \pm 15V, R_{Goff} = 0,62\Omega, T_{vj} = 125^\circ C$		-	0,18	-	μs
Einschaltverlustenergie pro Puls turn on energy loss per pulse	$I_C = 1200A, V_{CC} = 600V, L_s = 60nH$ $V_{GE} = \pm 15V, R_{Gon} = 1,8\Omega, T_{vj} = 125^\circ C$	E_{on}	-	245	-	mJ
Ausschaltverlustenergie pro Puls turn off energy loss per pulse	$I_C = 1200A, V_{CC} = 600V, L_s = 60nH$ $V_{GE} = \pm 15V, R_{Goff} = 0,62\Omega, T_{vj} = 125^\circ C$	E_{off}	-	190	-	mJ
Kurzschlussverhalten SC data	$t_P \leq 10\mu s, V_{GE} \leq 15V, T_{vj} \leq 125^\circ C$ $V_{CC} = 900V, V_{CEmax} = V_{CES} - L_{\sigma CE} \cdot di/dt $	I_{SC}	-	4800	-	A
Modulinduktivität stray inductance module		$L_{\sigma CE}$	-	12	-	nH
Leitungswiderstand, Anschluss-Chip lead resistance, terminal-chip	$T_c = 25^\circ C$	$R_{CC/EE}$	-	0,19	-	m Ω

Charakteristische Werte / characteristic values

Diode Wechselrichter / diode inverter

Durchlassspannung forward voltage	$I_F = I_{C, nom}, V_{GE} = 0V, T_{vj} = 25^\circ C$	V_F	-	2,0	2,5	V
	$I_F = I_{C, nom}, V_{GE} = 0V, T_{vj} = 125^\circ C$		-	1,8	-	V
Rückstromspitze peak reverse recovery current	$I_F = I_{C, nom}, -di_F/dt = 4800A/\mu s$	I_{RM}	-	390	-	A
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$ $V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$		-	620	-	A
Sperrverzögerungsladung recovered charge	$I_F = I_{C, nom}, -di_F/dt = 4800A/\mu s$	Q_r	-	55	-	μC
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$ $V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$		-	150	-	μC
Ausschaltenergie pro Puls reverse recovery energy	$I_F = I_{C, nom}, -di_F/dt = 4800A/\mu s$	E_{rec}	-	13	-	mJ
	$V_R = 600V, V_{GE} = -15V, T_{vj} = 25^\circ C$ $V_R = 600V, V_{GE} = -15V, T_{vj} = 125^\circ C$		-	35	-	mJ

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Thermische Eigenschaften / thermal properties

			min.	typ.	max.	
Innerer Wärmewiderstand thermal resistance, junction to case	pro Transistor /per transistor, DC	R_{thJC}	-	-	0,022	K/W
	pro Diode/per Diode, DC	R_{thJC}	-	-	0,040	K/W
Übergangs Wärmewiderstand thermal resistance, case to heatsink	pro Modul / per module $\lambda_{paste}/\lambda_{grease} = 1W/m^*K$	R_{thCK}	-	0,006	-	K/W
Höchstzulässige Sperrschichttemp. maximum junction temperature		$T_{vj\ max}$	-	-	150	°C
Betriebstemperatur operation temperature		$T_{vj\ op}$	-40	-	125	°C
Lagertemperatur storage temperature		T_{stg}	-40	-	125	°C

Mechanische Eigenschaften / mechanical properties

Gehäuse, siehe Anlage case, see appendix						
Innere Isolation internal insulation				Al_2O_3		
Kriechstrecke creepage distance				32		mm
Luftstrecke clearance				20		mm
CTI comperative tracking index				>400		
Anzugsdrehmoment, mech. Befestigung mounting torque	Schraube /screw M5	M	4,25	-	5,75	Nm
Anzugsdrehmoment, elektr. Anschlüsse terminal connection torque	Anschlüsse / terminal M4	M	1,7	-	2,3	Nm
	Anschlüsse / terminal M8	M	8	-	10	Nm
Gewicht weight		G		1500		g

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.

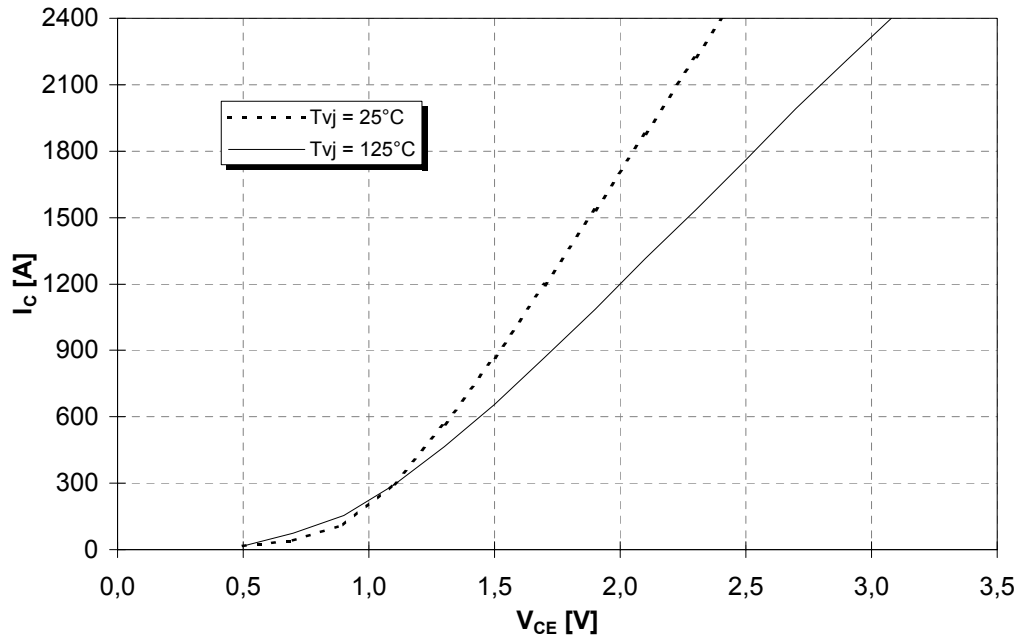
This technical information specifies semiconductor devices but promises no characteristics. It is valid with the belonging technical notes.



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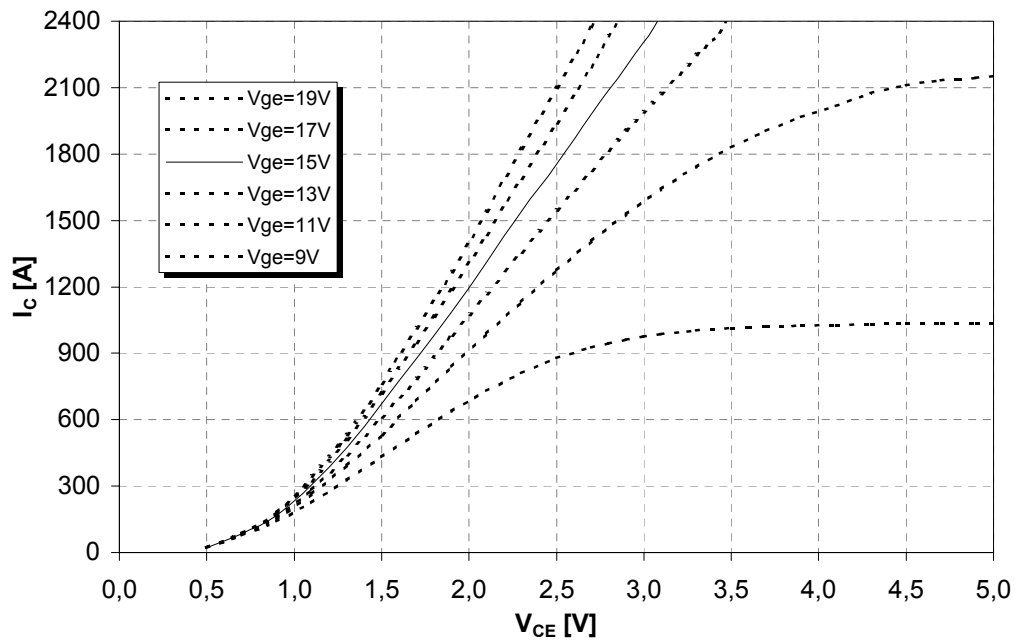
Ausgangskennlinie (typisch)
output characteristic (typical)

$I_C = f(V_{CE})$
 $V_{GE} = 15V$



Ausgangskennlinienfeld (typisch)
output characteristic (typical)

$I_C = f(V_{CE})$
 $T_{vj} = 125^\circ C$

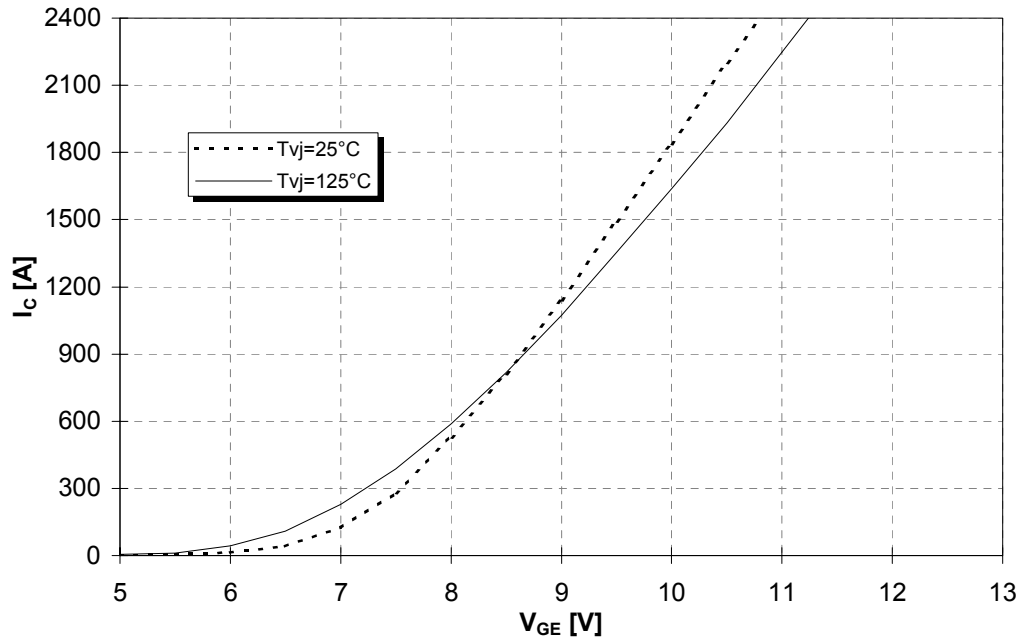




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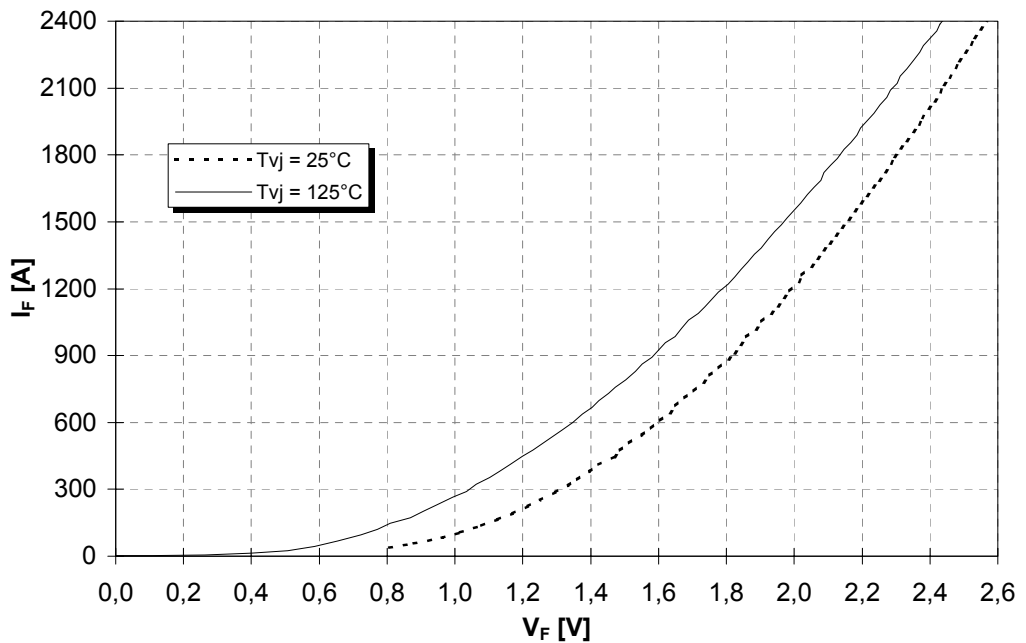
Übertragungscharakteristik (typisch)
transfer characteristic (typical)

$I_C = f(V_{GE})$
 $V_{CE} = 20V$



Durchlasskennlinie der Inversdiode (typisch)
forward characteristic of inverse diode (typical)

$I_F = f(V_F)$

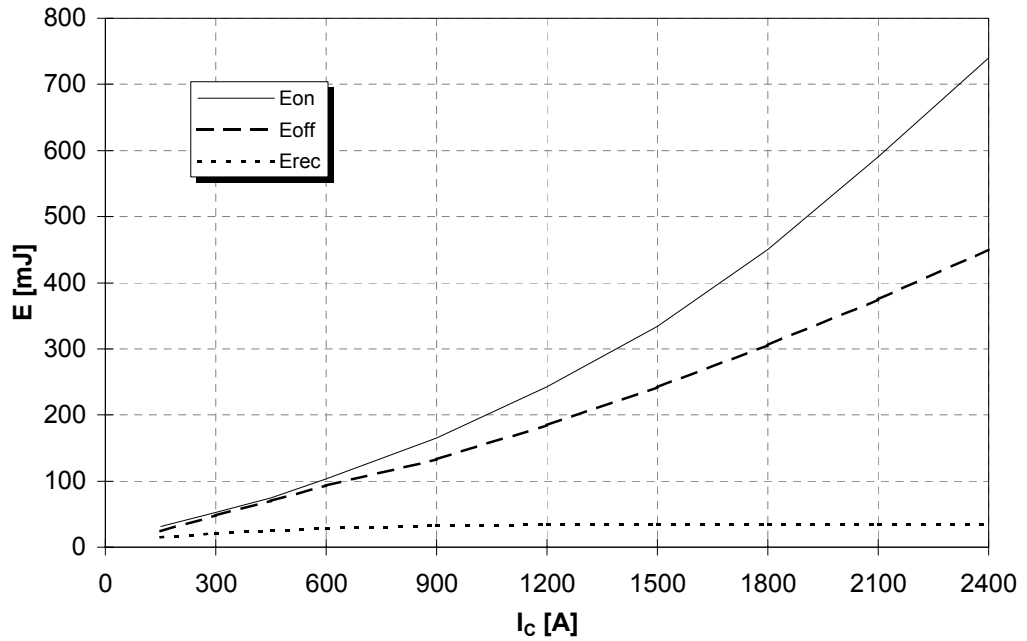




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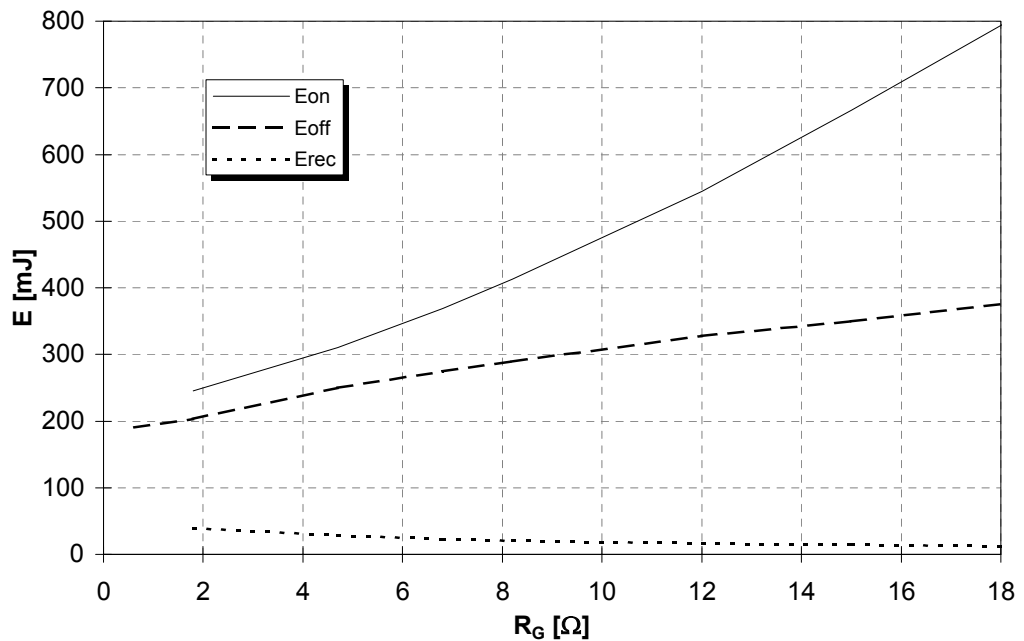
Schaltverluste (typisch)
Switching losses (typical)

$E_{on} = f(I_C)$, $E_{off} = f(I_C)$, $E_{rec} = f(I_C)$
 $V_{GE} = \pm 15V$, $R_{qon} = 1,8\Omega$, $R_{qoff} = 0,62\Omega$, $V_{CE} = 600V$, $T_{VI} = 125^\circ C$



Schaltverluste (typisch)
Switching losses (typical)

$E_{on} = f(R_G)$, $E_{off} = f(R_G)$, $E_{rec} = f(R_G)$
 $V_{GE} = \pm 15V$, $I_C = 1200A$, $V_{CE} = 600V$, $T_{VI} = 125^\circ C$

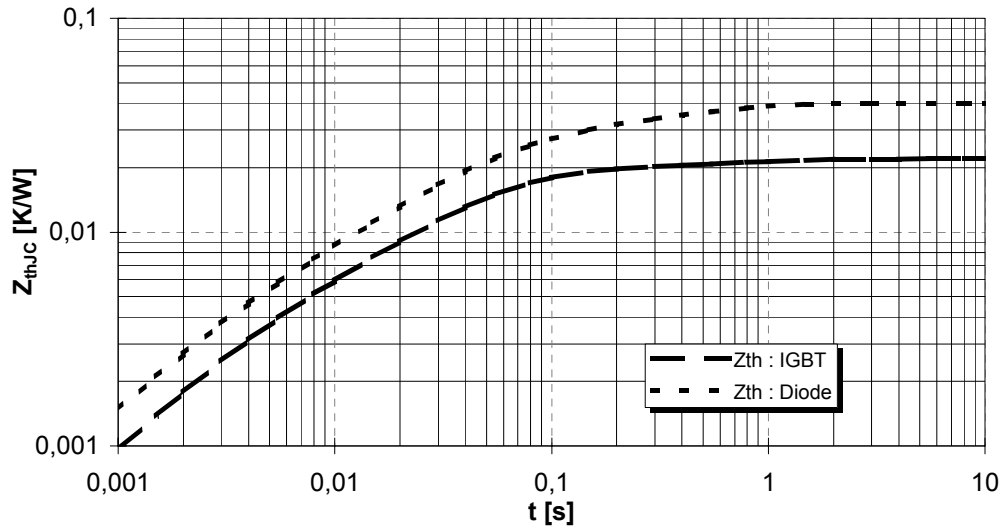




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Transienter Wärmewiderstand
Transient thermal impedance

$$Z_{thJC} = f(t)$$

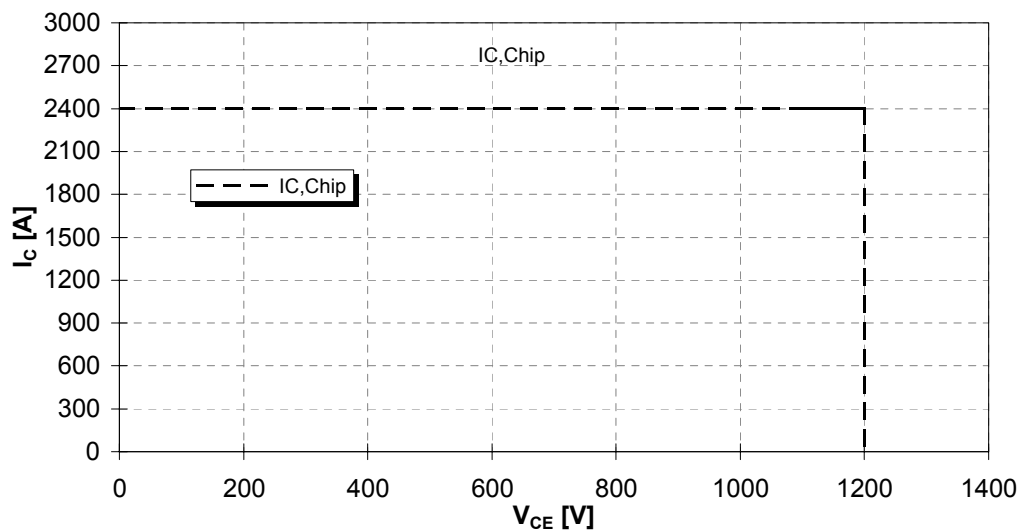


i	1	2	3	4
r_i [K/kW] : IGBT	2,63	8,62	8,49	2,26
τ_i [s] : IGBT	6,897E-01	5,634E-02	2,997E-02	3,820E-03
r_i [K/kW] : Diode	11,48	12,60	13,23	2,69
τ_i [s] : Diode	4,452E-01	7,451E-02	2,647E-02	2,850E-03

Sicherer Arbeitsbereich (RBSOA)

Reverse bias safe operation area (RBSOA)

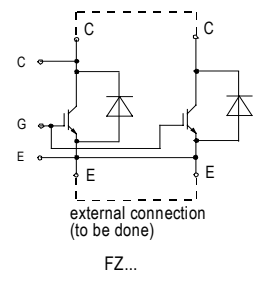
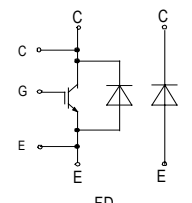
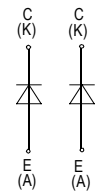
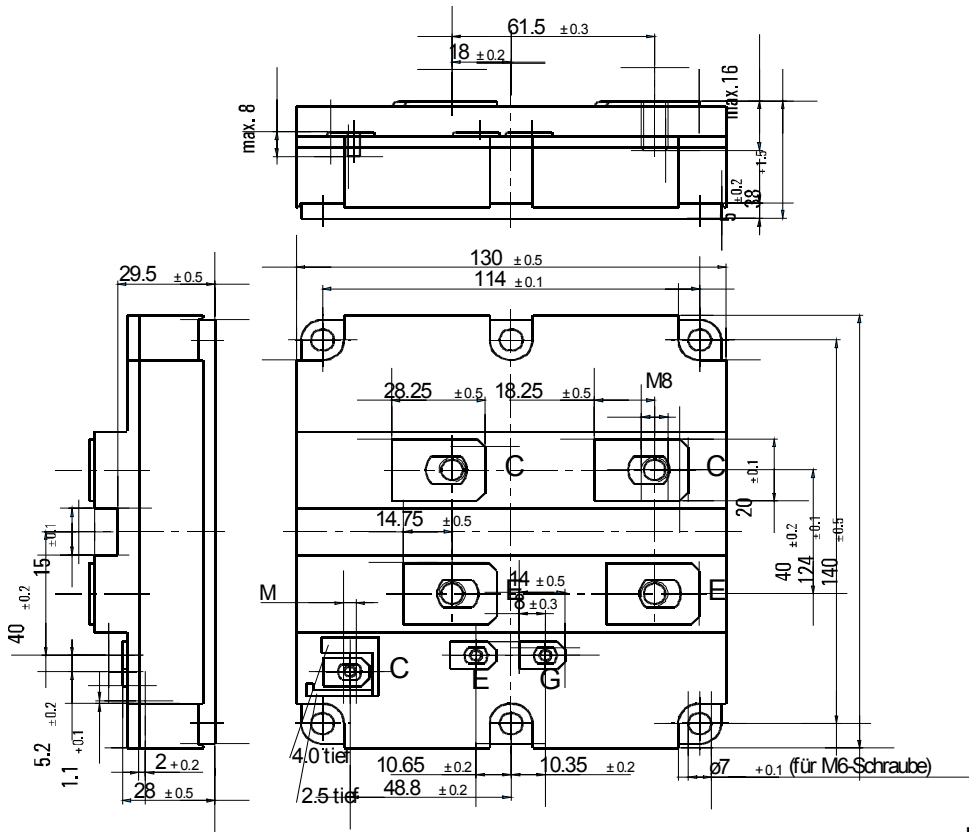
$$V_{GE} = \pm 15V, T_{vi} = 125^\circ C$$





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Gehäusemaße / Schaltbild
Package outline / Circuit diagram



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